

**CMLDM8005**  
**SURFACE MOUNT SILICON**  
**DUAL P-CHANNEL**  
**ENHANCEMENT-MODE**  
**MOSFET**



[www.centrasemi.com](http://www.centrasemi.com)



**SOT-563 CASE**

**DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CMLDM8005 consists of dual P-Channel enhancement-mode silicon MOSFETs designed for high speed pulsed amplifier and driver applications. These MOSFETs offer very low  $r_{DS(ON)}$  and low threshold voltage.

**MARKING CODE: CC8**

**FEATURES:**

- ESD protection up to 1800V (Human Body Model)
- 350mW power dissipation
- Very low  $r_{DS(ON)}$
- Low threshold voltage
- Logic level compatible
- Small, SOT-563 surface mount package
- Complementary dual N-Channel device: CMLDM7005

**APPLICATIONS:**

- Load switch/Level shifting
- Battery charging
- Boost switch
- Electro-luminescent backlighting

**MAXIMUM RATINGS:** ( $T_A=25^\circ\text{C}$ )

Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	8.0	V
Continuous Drain Current (Steady State - Note 1)	$I_D$	650	mA
Continuous Source Current (Body Diode)	$I_S$	250	mA
Maximum Pulsed Drain Current	$I_{DM}$	1.0	A
Power Dissipation (Note 1)	$P_D$	350	mW
Power Dissipation (Note 2)	$P_D$	300	mW
Power Dissipation (Note 2)	$P_D$	150	mW
Operating and Storage Junction Temperature	$T_J, T_{stg}$	-65 to +150	$^\circ\text{C}$
Thermal Resistance (Note 1)	$\theta_{JA}$	357	$^\circ\text{C/W}$

**SYMBOL**

SYMBOL	UNITS
$V_{DS}$	V
$V_{GS}$	V
$I_D$	mA
$I_S$	mA
$I_{DM}$	A
$P_D$	mW
$P_D$	mW
$P_D$	mW
$T_J, T_{stg}$	$^\circ\text{C}$
$\theta_{JA}$	$^\circ\text{C/W}$

**ELECTRICAL CHARACTERISTICS PER TRANSISTOR:** ( $T_A=25^\circ\text{C}$  unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
$I_{GSSF}, I_{GSSR}$	$V_{GS}=4.5V, V_{DS}=0$			10	$\mu\text{A}$
$I_{DSS}$	$V_{DS}=16V, V_{GS}=0$			100	nA
$BV_{DSS}$	$V_{GS}=0, I_D=250\mu\text{A}$	20			V
$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	0.5		1.0	V
$V_{SD}$	$V_{GS}=0, I_S=250\text{mA}$			1.1	V
$r_{DS(ON)}$	$V_{GS}=4.5V, I_D=350\text{mA}$		0.25	0.36	$\Omega$
$r_{DS(ON)}$	$V_{GS}=2.5V, I_D=300\text{mA}$		0.37	0.5	$\Omega$
$r_{DS(ON)}$	$V_{GS}=1.8V, I_D=150\text{mA}$			0.8	$\Omega$

Notes: (1) Ceramic or aluminum core PC Board with copper mounting pad area of 4.0mm<sup>2</sup>  
(2) FR-4 Epoxy PC Board with copper mounting pad area of 4.0mm<sup>2</sup>  
(3) FR-4 Epoxy PC Board with copper mounting pad area of 1.4mm<sup>2</sup>

**CMLDM8005**

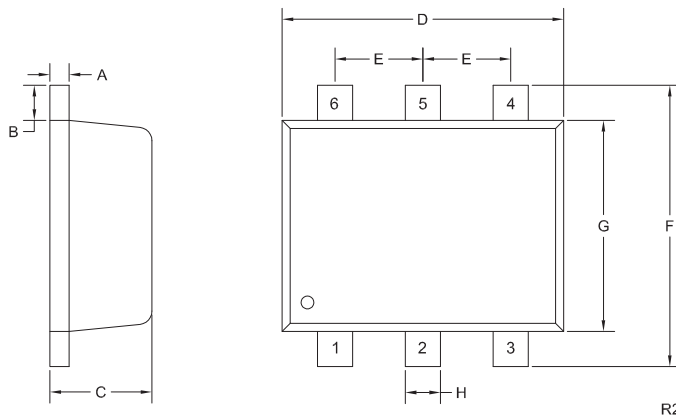
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**ELECTRICAL CHARACTERISTICS PER TRANSISTOR - Continued:** ( $T_A=25^\circ\text{C}$  unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	UNITS
$g_{FS}$	$V_{DS}=10\text{V}, I_D=200\text{mA}$	0.2		S
$C_{rss}$	$V_{DS}=16\text{V}, V_{GS}=0, f=1.0\text{MHz}$		25	pF
$C_{iss}$	$V_{DS}=16\text{V}, V_{GS}=0, f=1.0\text{MHz}$		100	pF
$C_{oss}$	$V_{DS}=16\text{V}, V_{GS}=0, f=1.0\text{MHz}$		21	pF
$Q_{g(\text{tot})}$	$V_{DS}=10\text{V}, V_{GS}=4.5\text{V}, I_D=200\text{mA}$		1.2	nC
$Q_{gs}$	$V_{DS}=10\text{V}, V_{GS}=4.5\text{V}, I_D=200\text{mA}$		0.24	nC
$Q_{gd}$	$V_{DS}=10\text{V}, V_{GS}=4.5\text{V}, I_D=200\text{mA}$		0.36	nC
$t_{on}$	$V_{DD}=10\text{V}, V_{GS}=4.5\text{V}, I_D=200\text{mA}, R_G=10\Omega$		38	ns
$t_{off}$	$V_{DD}=10\text{V}, V_{GS}=4.5\text{V}, I_D=200\text{mA}, R_G=10\Omega$		48	ns

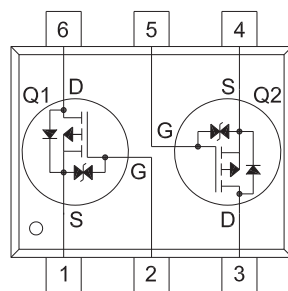
**SOT-563 CASE - MECHANICAL OUTLINE**



SYMBOL	DIMENSIONS			
	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.0027	0.007	0.07	0.18
B	0.008		0.20	
C	0.017	0.024	0.45	0.60
D	0.059	0.067	1.50	1.70
E	0.020		0.50	
F	0.059	0.067	1.50	1.70
G	0.043	0.051	1.10	1.30
H	0.006	0.012	0.15	0.30

SOT-563 (REV: R2)

**PIN CONFIGURATION**



**LEAD CODE:**

- 1) Source Q1
- 2) Gate Q1
- 3) Drain Q2
- 4) Source Q2
- 5) Gate Q2
- 6) Drain Q1

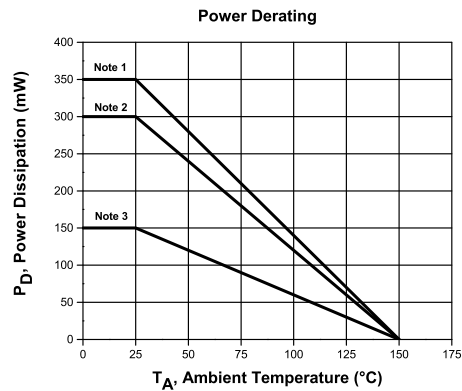
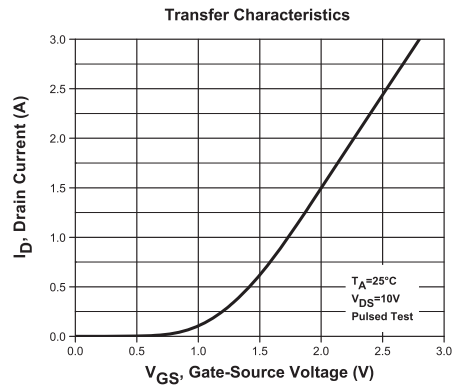
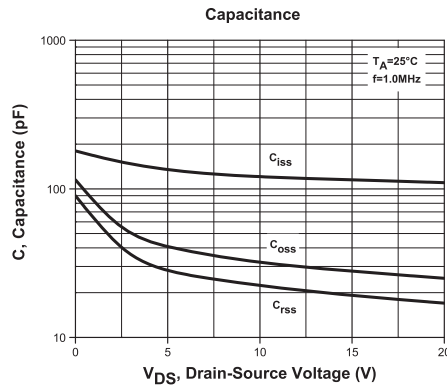
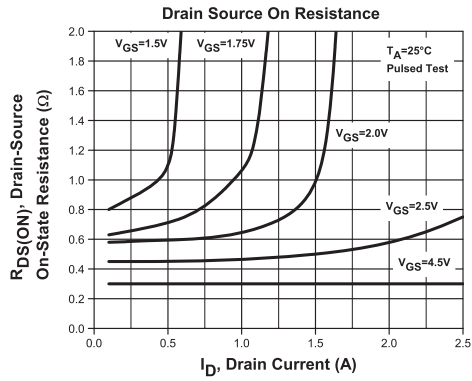
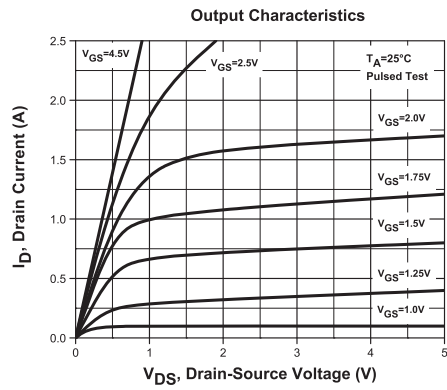
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R6 (8-June 2015)

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**TYPICAL ELECTRICAL CHARACTERISTICS**



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#### Как с нами связаться

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